

Amendments to the Specification

Please replace the paragraph beginning at line 24 on page 37 and ending at line 6 on page 38 with the following amended paragraph:

Next, in the condition of FIG. 10A, ~~the a~~ layer ~~3A~~ is deposited by sputtering, vapor deposition or the like. Generally, a layer deposited by sputtering, vapor deposition or the like bulges at either end of the photoresist as is illustrated by 3D in FIG. 10B. This is because more material is deposited on the upper part of either sidewall of the layer ~~3A~~ 10B than on the lower part thereof, even after the layer is formed. As a result of such a gradual growth on the sidewall, a slope is formed on either end of the photoresist.

Please replace the paragraph beginning at line 20 of page 39 and ending at line 1 of page 40 with the following amended paragraph:

The optical terminal of the component is an optical rod 12 having, for example, a spherically tapered end. The optical rod 12 is inserted into the concave made in the cover layer 11, as is illustrated in FIG. 12. This renders it unnecessary to align the optical axis of the optical terminal of the mounted component with the optical axis of the optical connection board. The time required to mount the component on the optical connection board can therefore be much shortened.